

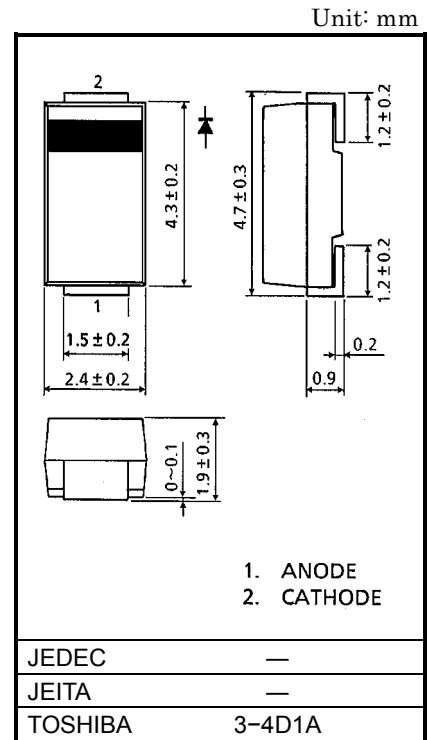
U2GWJ44

SWITCHING MODE POWER SUPPLY APPLICATION

- Low Forward Voltage : $V_{FM} = 0.55V$ (Max)
- Average Forward Current : $I_F (AV) = 2.0A$
- Repetitive Peak Reverse Voltage : $V_{RRM} = 40V$
- Surface Mounting Plastic Mold Package

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Reverse Voltage	V_{RRM}	40	V
Average Forward Current	$I_F (AV)$	2.0	A
Peak One Cycle Surge Forward Current (Non-Repetitive)	I_{FSM}	40 (50 Hz)	A
Junction Temperature	T_j	-40~125	°C
Storage Temperature Range	T_{stg}	-40~125	°C

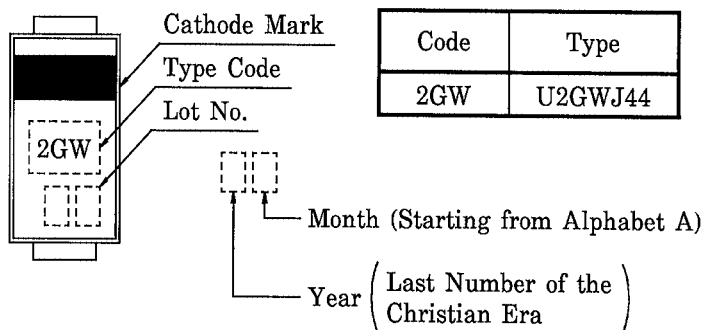
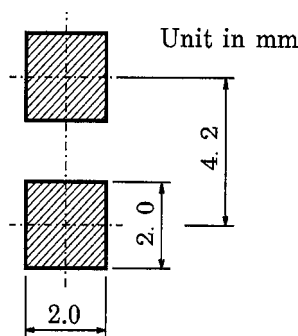


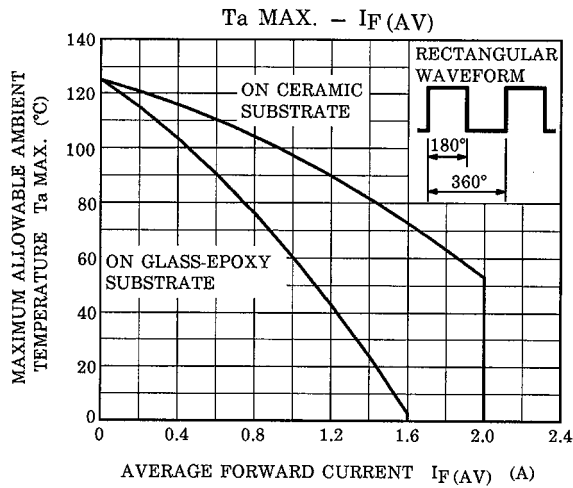
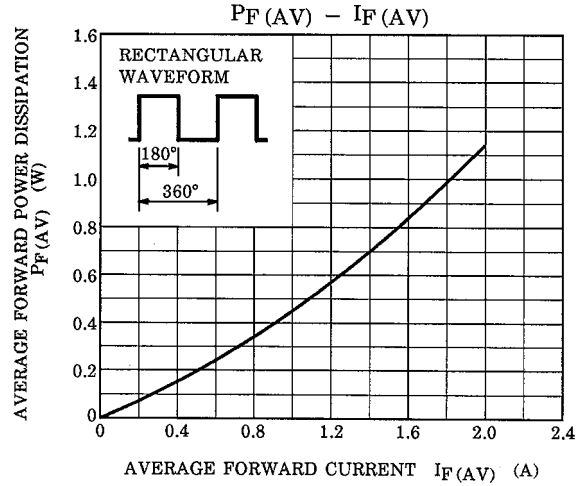
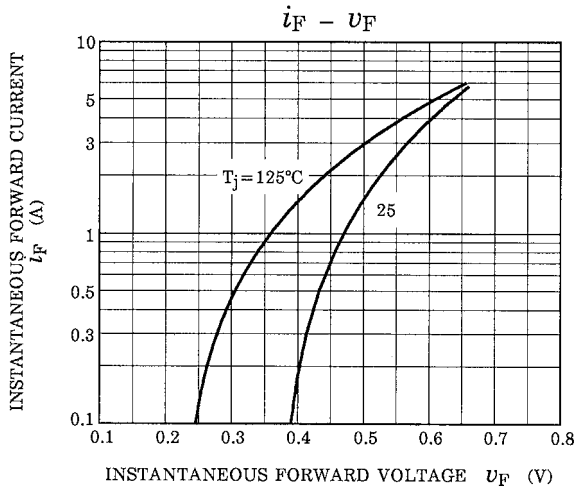
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Weight: 0.06g

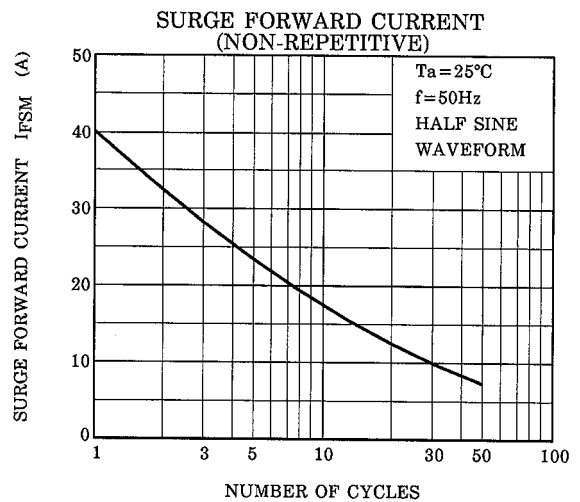
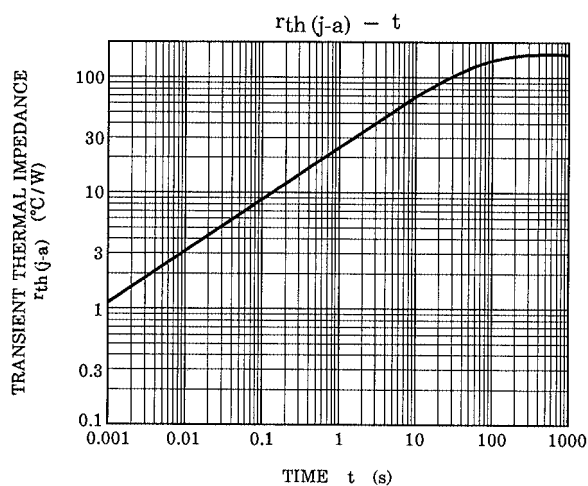
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Peak Forward Voltage	V_{FM}	$I_{FM} = 2.0A$	—	—	0.55	V
Repetitive Peak Reverse Current	I_{RRM}	$V_{RRM} = 40V$	—	—	500	μA
Junction Capacitance	C_j	$V_R = 10V, f = 1.0MHz$	—	125	—	pF
Thermal Resistance (Junction to Ambient)	$r_{th (j-a)}$	On ceramic substrate	—	—	60	°C / W
		On glass-epoxy substrate	—	—	145	

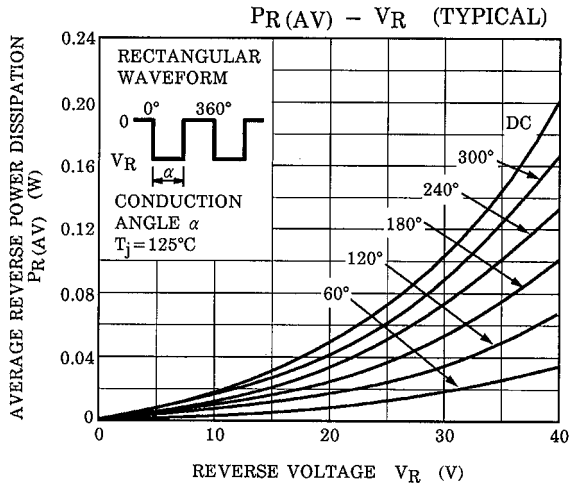
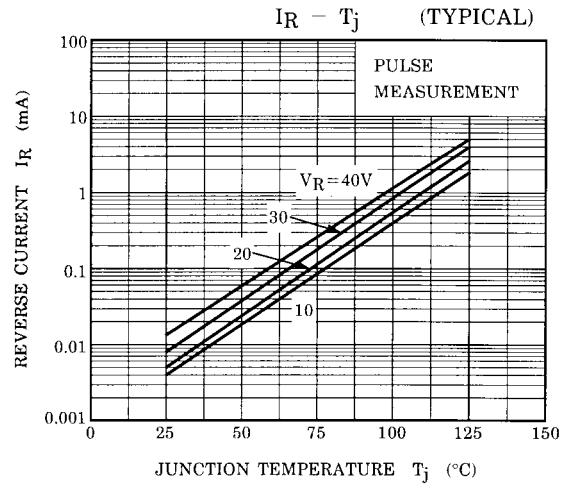
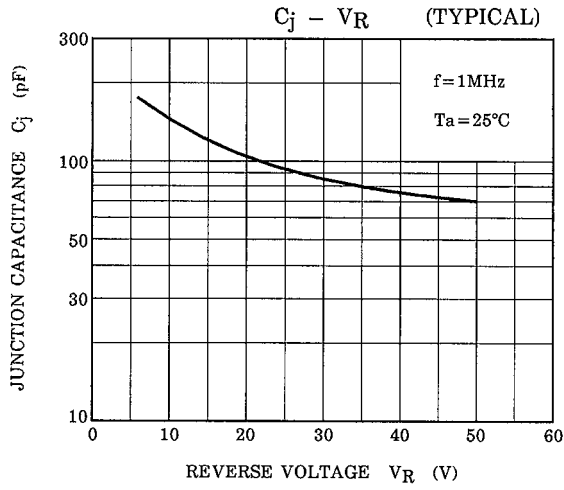
STANDARD SOLDERING PAD MARKING





	ON CERAMIC SUBSTRATE	ON GLASS-EPOXY SUBSTRATE
Soldering land : a	2mm×2mm	6mm×6mm
Substrate size : b	50mm×50mm	50mm×50mm
Substrate thickness : c	0.64mm	1.6mm





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